

PESDxV4UW series

Very low capacitance quadruple ESD protection diode arrays in SOT665 package

Rev. 01 — 22 April 2005

Product data sheet

1. Product profile

1.1 General description

Very low capacitance quadruple ElectroStatic Discharge (ESD) protection diode arrays in ultra small SOT665 plastic package designed to protect up to four signal lines from the damage caused by ESD and other transients.

1.2 Features

- ESD protection of up to four lines
- Very low diode capacitance
- Low clamping voltage
- Ultra low leakage current: $I_{RM} = 3 \text{ nA}$
- ESD protection up to 12 kV
- IEC 61000-4-2; level 4 (ESD)

1.3 Applications

- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems
- Portable electronics
- Subscriber Identity Module (SIM) card protection

1.4 Quick reference data

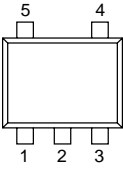
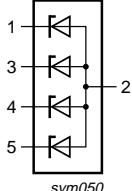
Table 1: Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{RWM}	reverse stand-off voltage					
	PESD3V3V4UW		-	-	3.3	V
	PESD5V0V4UW		-	-	5.0	V
C_d	diode capacitance	$f = 1 \text{ MHz};$ see Figure 5 ; $V_R = 0 \text{ V}$				
	PESD3V3V4UW		-	15	18	pF
	PESD5V0V4UW		-	12	15	pF

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2. Pinning information

Table 2: Pinning

Pin	Description	Simplified outline	Symbol
1	cathode 1		
2	common anode		
3	cathode 2		
4	cathode 3		
5	cathode 4		

3. Ordering information

Table 3: Ordering information

Type number	Package		
	Name	Description	Version
PESD3V3V4UW	-	plastic surface mounted package; 5 leads	SOT665
PESD5V0V4UW	-		

4. Marking

Table 4: Marking codes

Type number	Marking code
PESD3V3V4UW	W1
PESD5V0V4UW	W2

5. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P _{PP}	peak pulse power	8/20 μ s	[1][2]		
	PESD3V3V4UW		-	16	W
	PESD5V0V4UW		-	16	W
I _{PP}	peak pulse current	8/20 μ s	[1][2]		
	PESD3V3V4UW		-	1.5	A
	PESD5V0V4UW		-	1.5	A

Table 5: Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
T _j	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC 61000-4-5; see [Figure 1](#).

[2] Measured from pin 1, 3, 4 or 5 to 2.

Table 6: ESD maximum ratings

Symbol	Parameter	Conditions	Min	Max	Unit
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2 (contact discharge)	[1] [2]		
	PESD3V3V4UW		-	12	kV
	PESD5V0V4UW		-	12	kV
	PESDxV4UW series	HBM MIL-STD 883	-	10	kV

[1] Device stressed with ten non-repetitive ESD pulses; see [Figure 2](#).

[2] Measured from pin 1, 3, 4 or 5 to 2.

Table 7: ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD); see Figure 2	> 8 kV (contact)
HBM MIL-STD 883; class 3	> 4 kV

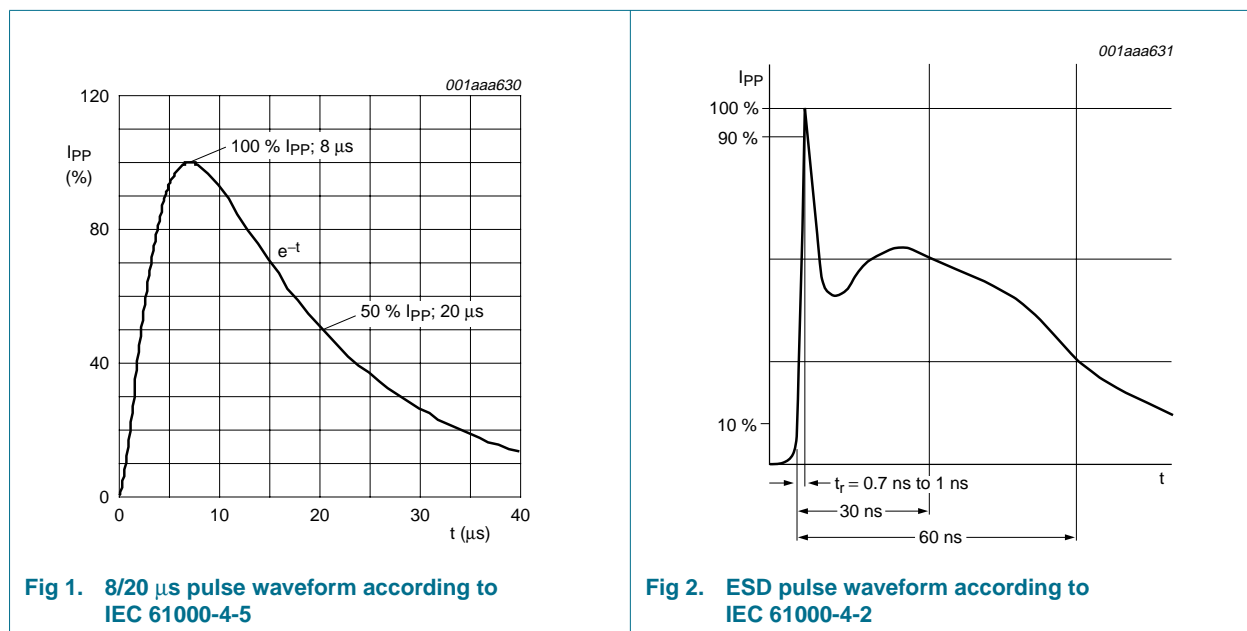


Fig 1. 8/20 μs pulse waveform according to IEC 61000-4-5

Fig 2. ESD pulse waveform according to IEC 61000-4-2

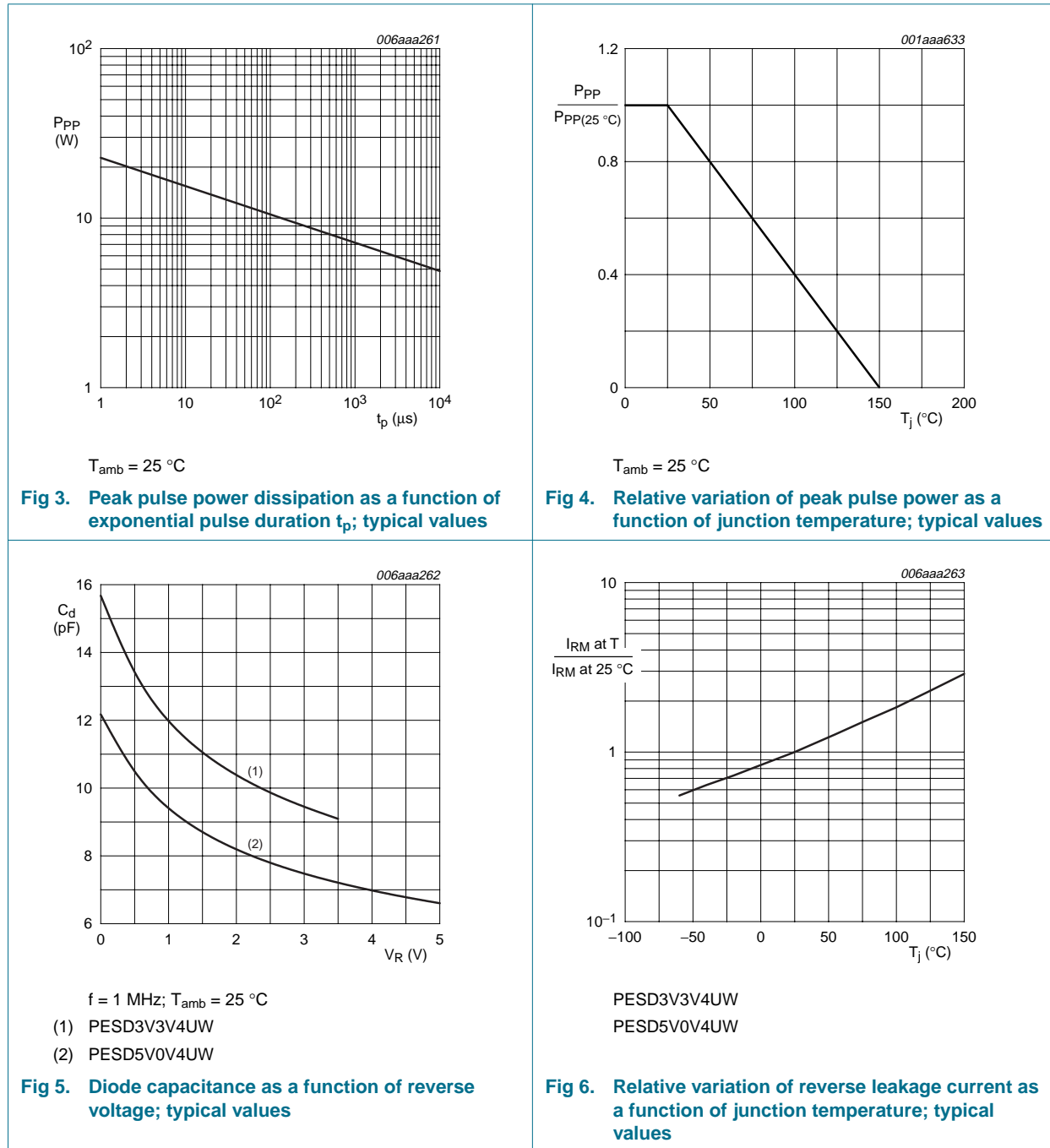
6. Characteristics

Table 8: Characteristics
T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per diode						
V _{RWM}	reverse stand-off voltage					
	PESD3V3V4UW		-	-	3.3	V
	PESD5V0V4UW		-	-	5.0	V
I _{RM}	reverse leakage current	see Figure 6 ;				
	PESD3V3V4UW	V _{RWM} = 3.3 V	-	40	300	nA
	PESD5V0V4UW	V _{RWM} = 5.0 V	-	3	25	nA
V _{BR}	breakdown voltage	I _R = 1 mA				
	PESD3V3V4UW		5.3	5.6	5.9	V
	PESD5V0V4UW		6.4	6.8	7.2	V
C _d	diode capacitance	f = 1 MHz; see Figure 5 ;				
	PESD3V3V4UW	V _R = 0 V	-	15	18	pF
		V _R = 3.3 V	-	9	12	pF
	PESD5V0V4UW	V _R = 0 V	-	12	15	pF
		V _R = 5 V	-	6	9	pF
V _{CL}	clamping voltage					[1] [2]
	PESD3V3V4UW	I _{PP} = 1 A	-	-	9	V
		I _{PP} = 2 A	-	-	11	V
	PESD5V0V4UW	I _{PP} = 1 A	-	-	11	V
		I _{PP} = 1.7 A	-	-	13	V
r _{dif}	differential resistance	I _R = 1 mA				
	PESD3V3V4UW		-	-	200	Ω
	PESD5V0V4UW		-	-	100	Ω

[1] Non-repetitive current pulse 8/20 μs exponential decay waveform according to IEC 61000-4-5; see [Figure 1](#).

[2] Measured from pin 1, 3, 4 or 5 to 2.



7. Application information

The PESDxV4UW series is designed for protection of up to four unidirectional data lines from the damage caused by ESD and surge pulses. The PESDxV4UW series may be used on lines where the signal polarities are above or below ground. The PESDxV4UW series provides a surge capability of 16 W per line for an 8/20 μ s waveform.

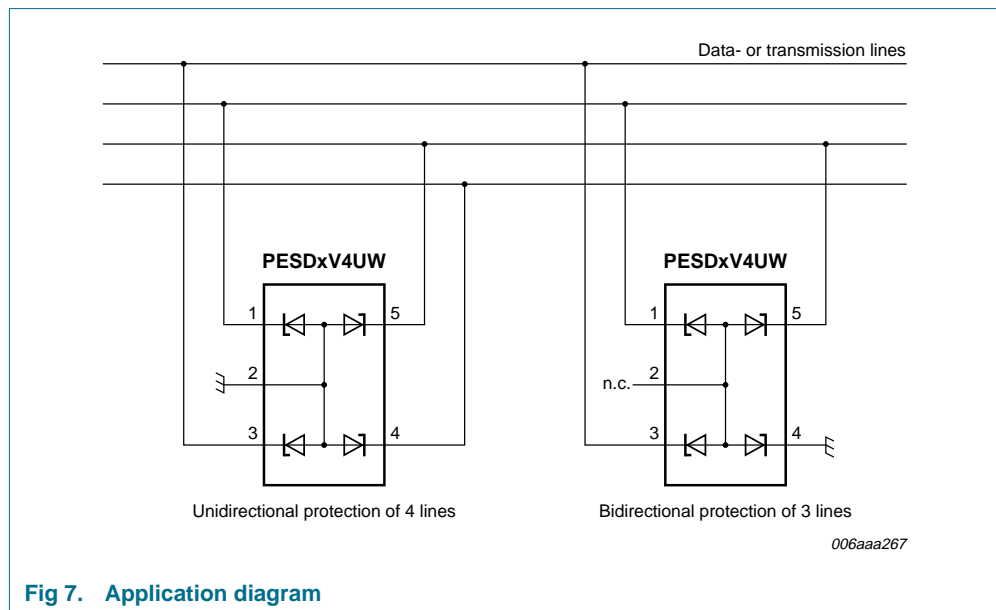


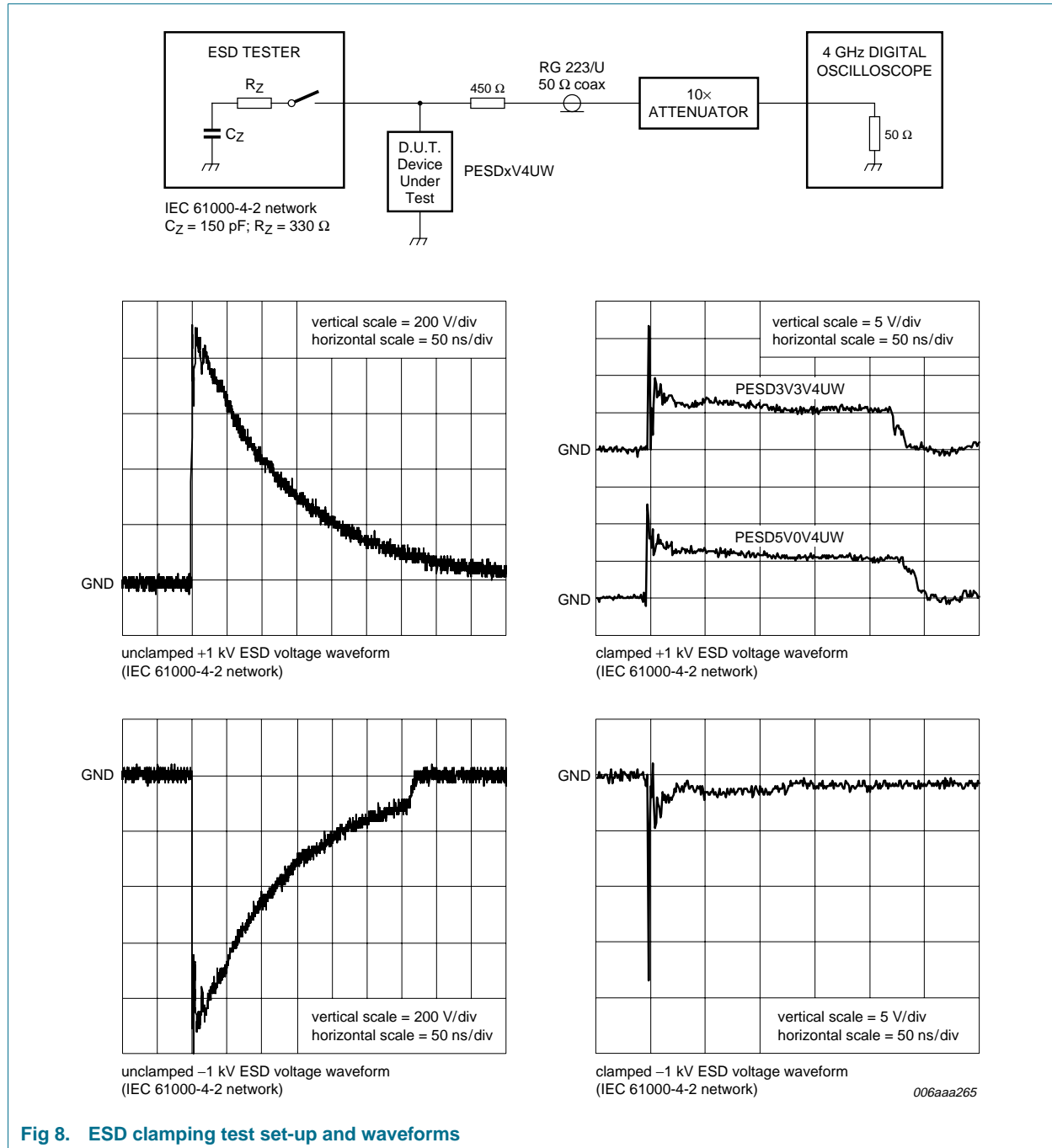
Fig 7. Application diagram

Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the PESDxV4UW as close to the input terminal or connector as possible.
2. The path length between the PESDxV4UW and the protected line should be minimized.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all printed-circuit board conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Ground planes should be used whenever possible. For multilayer printed-circuit boards, use ground vias.

8. Test information



9. Package outline

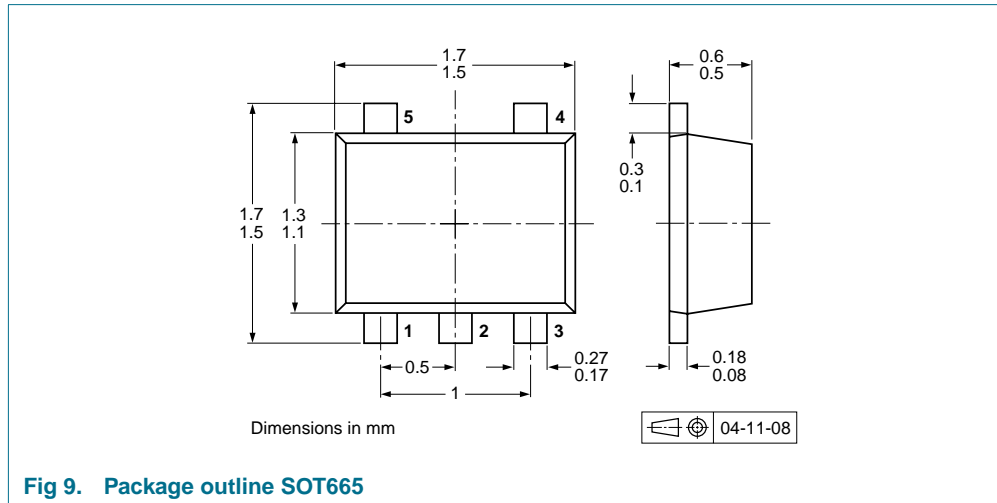


Fig 9. Package outline SOT665

10. Packing information

Table 9: Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

Type number	Package	Description	Packing quantity
			4000
PESD3V3V4UW	SOT665	4 mm pitch, 8 mm tape and reel	-115
PESD5V0V4UW			

[1] For further information and the availability of packing methods, see [Section 15](#).



11. Revision history

Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
PESDXV4UW_SER_1	20050422	Product data sheet	-	9397 750 14481	-

12. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

13. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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16. Contents

1	Product profile	1
1.1	General description.	1
1.2	Features	1
1.3	Applications	1
1.4	Quick reference data.	1
2	Pinning information	2
3	Ordering information	2
4	Marking	2
5	Limiting values	2
6	Characteristics	4
7	Application information	6
8	Test information	7
9	Package outline	8
10	Packing information	8
11	Revision history	9
12	Data sheet status	10
13	Definitions	10
14	Disclaimers	10
15	Contact information	10



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